10-bit bus switch with 5-bit output enables

Rev. 1 — 30 December 2010

**Product data sheet** 

### 1. General description

The 74CBTLV3384 is a dual 5-pole, single-throw bus switch. The device features two output enable inputs (nOE) that each control five switch channels. The switches are disabled when the associated nOE input is HIGH. Schmitt-trigger action at control inputs makes the circuit tolerant of slower input rise and fall times. This device is fully specified for partial power-down applications using  $I_{OFF}$ . The  $I_{OFF}$  circuitry disables the output, preventing the damaging backflow current through the device when it is powered down.

### 2. Features and benefits

- Supply voltage range from 2.3 V to 3.6 V
- High noise immunity
- Complies with JEDEC standard:
  - JESD8-5 (2.3 V to 2.7 V)
  - ◆ JESD8-B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
  - CDM AEC-Q100-011 revision B exceeds 1000 V
- 5 Ω switch connection between two ports
- Rail to rail switching on data I/O ports
- CMOS low power consumption
- Latch-up performance exceeds 250 mA per JESD78B Class I level A
- I<sub>OFF</sub> circuitry provides partial Power-down mode operation
- Multiple package options
- Specified from -40 °C to +85 °C and -40 °C to +125 °C



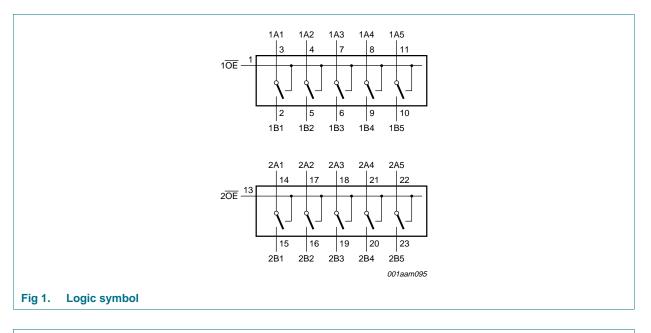
10-bit bus switch with 5-bit output enables

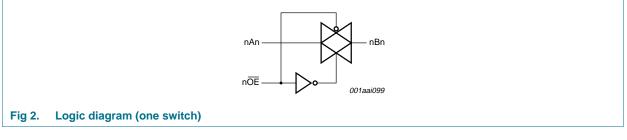
### 3. Ordering information

Type number Package								
	Temperature range	Name	Description	Version				
74CBTLV3384DK	–40 °C to +125 °C	SSOP24[1]	plastic shrink small outline package; 24 leads; body width 3.9 mm; lead pitch 0.635 mm	SOT556-1				
74CBTLV3384PW	–40 °C to +125 °C	TSSOP24	plastic thin shrink small outline package; 24 leads; body width 4.4 mm	SOT355-1				
74CBTLV3384BQ	–40 °C to +125 °C	DHVQFN24	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body $3.5 \times 5.5 \times 0.85$ mm	SOT815-1				

[1] Also known as QSOP24 package

### 4. Functional diagram



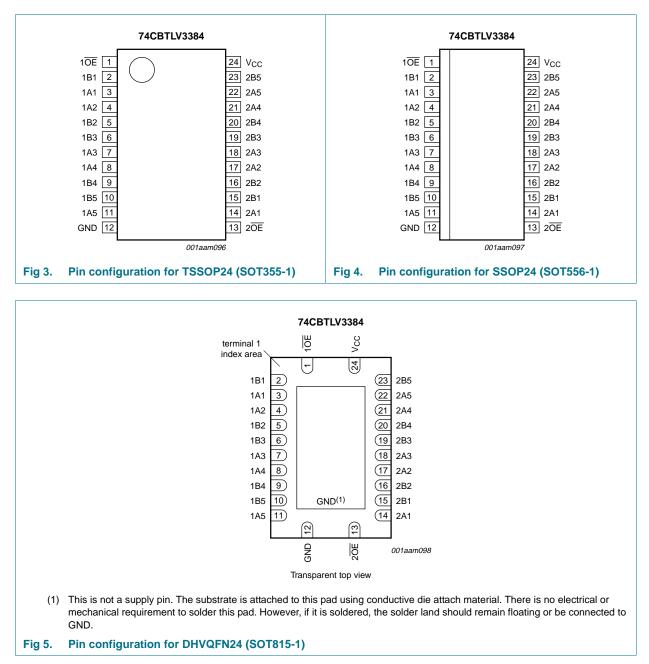


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Rev. 1 — 30 December 2010	2 of 18
	· · · · ·

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### 5. Pinning information

#### 5.1 Pinning



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Rev. 1 — 30 December 2010

#### 10-bit bus switch with 5-bit output enables

#### 5.2 Pin description

Table 2. Pin descri	ption	
Symbol	Pin	Description
10E, 20E	1, 13	output enable input (active LOW)
1A1 to 1A5	3, 4, 7, 8, 11	data input/output (A port)
2A1 to 2A5	14, 17, 18, 21, 22	data input/output (A port)
1B1 to 1B5	2, 5, 6, 9, 10	data input/output (B port)
2B1 to 2B5	15, 16, 19, 20, 23	data input/output (B port)
GND	12	ground (0 V)
V <sub>CC</sub>	24	positive supply voltage

### 6. Functional description

#### Table 3. Function selection<sup>[1]</sup> Input Input/output 10E 2OE 2An, 2Bn 1An, 1Bn L L 1An = 1Bn 2An = 2Bn L н 1An = 1BnΖ Н L Ζ 2An = 2Bn Ζ н Ζ Н

[1] H = HIGH voltage level; L = LOW voltage level; Z = high-impedance OFF-state.

### 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

			0	10	,
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		-0.5	+4.6	V
VI	input voltage		<u>[1]</u> –0.5	+4.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	<u>[1]</u> –0.5	$V_{CC} + 0.5$	V
I <sub>IK</sub>	input clamping current	$V_{I} < -0.5 V$	-50	-	mA
I <sub>SK</sub>	switch clamping current	$V_{I} < -0.5 V$	-50	-	mA
I <sub>SW</sub>	switch current	$V_{SW} = 0 V \text{ to } V_{CC}$	-	±128	mA
I <sub>CC</sub>	supply current		-	+100	mA
I <sub>GND</sub>	ground current		-100	-	mA
T <sub>stg</sub>	storage temperature		-65	+150	°C
P <sub>tot</sub>	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	[2] _	500	mW

[1] The minimum input and output voltage ratings may be exceeded if the input and output current ratings are observed.

For SSOP24 and TSSOP24 packages: P<sub>tot</sub> derates linearly with 5.5 mW/K above 60 °C.
 For DHVQFN24 package: P<sub>tot</sub> derates linearly at 4.5 mW/K above 60 °C.

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### 8. Recommended operating conditions

Table 5.	Recommended operating condition	ons			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	supply voltage		2.3	3.6	V
VI	input voltage		0	3.6	V
V <sub>SW</sub>	switch voltage	enable and disable mode	0	$V_{CC}$	V
T <sub>amb</sub>	ambient temperature		-40	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.3 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[1]</u> _	200	ns/V

[1] Applies to control signal levels.

#### 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions voltages are referenced to GND (ground = 0 V).

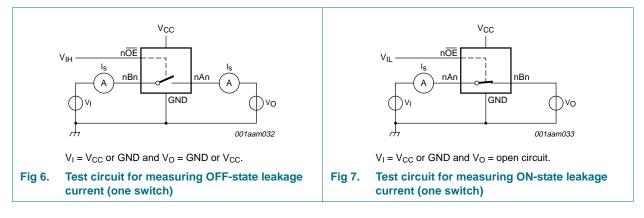
Symbol	Parameter	Conditions	T <sub>amb</sub> =	–40 °C to	+85 °C	$T_{amb} = -40$ °	C to +125 °C	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	1
V <sub>IH</sub>	HIGH-level	$V_{CC}$ = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
	input voltage	$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
V <sub>IL</sub>	•	$V_{CC}$ = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	voltage	$V_{CC}$ = 3.0 V to 3.6 V	-	-	0.9	-	0.9	V
l <sub>l</sub>	input leakage current	pin n $\overline{OE}$ ; V <sub>I</sub> = GND to V <sub>CC</sub> ; V <sub>CC</sub> = 3.6 V	-	-	±1	-	±20	μA
I <sub>S(OFF)</sub>	OFF-state leakage current	$V_{CC} = 3.6 \text{ V}; \text{ see } \frac{\text{Figure 6}}{1000}$	-	-	±1	-	±20	μΑ
I <sub>S(ON)</sub>	ON-state leakage current	$V_{CC} = 3.6 \text{ V}; \text{ see } \frac{\text{Figure 7}}{\text{Figure 7}}$	-	-	±1	-	±20	μΑ
I <sub>OFF</sub>	power-off leakage current	$V_1 \text{ or } V_0 = 0 \text{ V to } 3.6 \text{ V};$ $V_{CC} = 0 \text{ V}$	-	-	±10	-	±50	μΑ
I <sub>CC</sub>	supply current		-	-	10	-	50	μA
$\Delta I_{CC}$	additional supply current	pin n $\overline{OE}$ ; V <sub>1</sub> = V <sub>CC</sub> - 0.6 V; V <sub>SW</sub> = GND or V <sub>CC</sub> ; V <sub>CC</sub> = 3.6 V	<u>2]</u> _	-	300	-	2000	μA
CI	input capacitance	pin n $\overline{OE}$ ; V <sub>CC</sub> = 3.3 V; V <sub>I</sub> = 0 V to 3.3 V	-	0.9	-	-	-	pF
$C_{S(OFF)}$	OFF-state capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = 0 V to 3.3 V	-	5.2	-	-	-	рF
C <sub>S(ON)</sub>	ON-state capacitance	$V_{CC}$ = 3.3 V; $V_{I}$ = 0 V to 3.3 V	-	14.3	-	-	-	pF

[1] All typical values are measured at  $T_{amb}$  = 25 °C.

[2] One input at 3 V, other inputs at  $V_{CC}$  or GND.

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#### 9.1 Test circuits



#### 9.2 ON resistance

#### Table 7. Resistance R<sub>ON</sub>

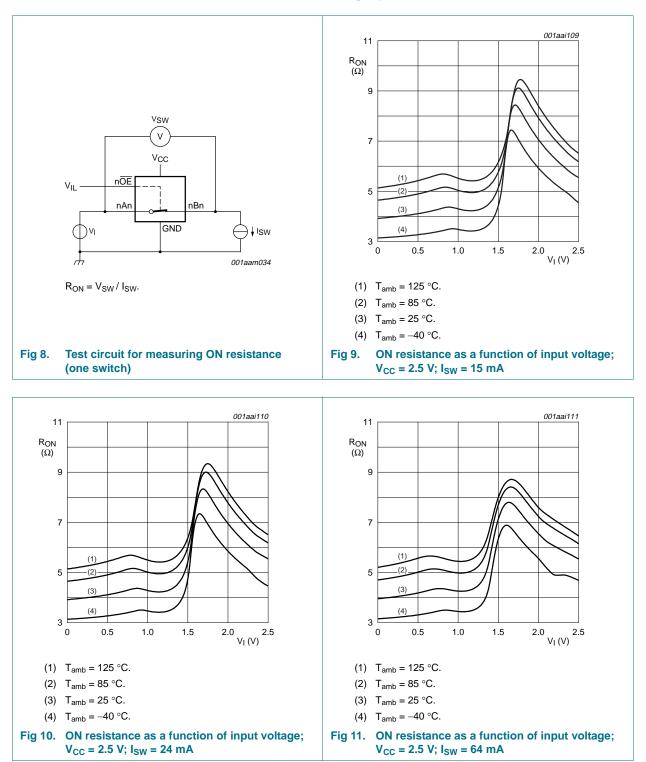
At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Figure 8.

Symbol	Parameter	neter Conditions $T_{amb} = -40 \degree C$ to +85 $\degree C$		$T_{amb}$ = -40 °C to +125 °C		Unit		
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
-	$V_{CC} = 2.3 V \text{ to } 2.7 V;$ [2] see Figure 9 to Figure 11							
	$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω	
	$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.2	8.0	-	15.0	Ω	
	I <sub>SW</sub> = 15 mA; V <sub>I</sub> = 1.7 V	-	8.4	40	-	60.0	Ω	
	$V_{CC} = 3.0 V$ to 3.6 V; see <u>Figure 12</u> to <u>Figure 14</u>							
	$I_{SW} = 64 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω	
	$I_{SW} = 24 \text{ mA}; V_I = 0 \text{ V}$	-	4.0	7.0	-	11.0	Ω	
		$I_{SW} = 15 \text{ mA}; V_1 = 2.4 \text{ V}$	-	6.2	15	-	25.5	Ω

[1] Typical values are measured at  $T_{amb}$  = 25 °C and nominal V<sub>CC</sub>.

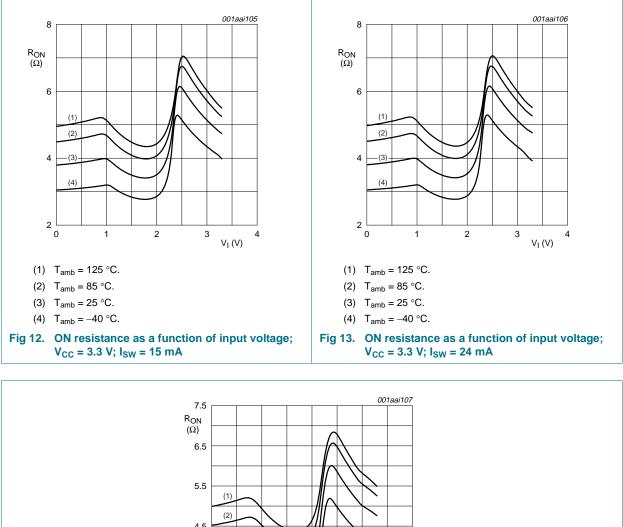
[2] Measured by the voltage drop between the A and B terminals at the indicated current through the switch. ON-state resistance is determined by the lower of the voltages of the two (A or B) terminals.

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#### 9.3 ON resistance test circuit and graphs

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4.5 -(3) 3.5 (4) 2.5 0 1 2 3 4 V<sub>I</sub> (V) (1)  $T_{amb} = 125 \ ^{\circ}C.$ (2) T<sub>amb</sub> = 85 °C. (3) T<sub>amb</sub> = 25 °C. (4)  $T_{amb} = -40 \ ^{\circ}C.$ Fig 14. ON resistance as a function of input voltage;  $V_{CC}$  = 3.3 V;  $I_{SW}$  = 64 mA

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### **10.** Dynamic characteristics

#### Table 8. Dynamic characteristics

GND = 0 V; for test circuit see Figure 17

Symbol	Parameter	Conditions		$T_{amb}$ = -40 °C to +85 °C			$T_{amb}$ = -40 °C to +125 °C		Unit
				Min	Typ[1]	Max	Min	Max	
t <sub>pd</sub>	propagation delay	nAn to nBn or nBn to nAn; see <u>Figure 15</u>	[2][3]						
		$V_{CC}$ = 2.3 V to 2.7 V		-	-	0.13	-	0.20	ns
		$V_{CC}$ = 3.0 V to 3.6 V		-	-	0.20	-	0.31	ns
t <sub>en</sub>	enable time	n <mark>OE</mark> to nAn or nBn; see <u>Figure 16</u>	<u>[4]</u>						
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	3.0	5.0	1.0	7.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.0	2.6	4.3	1.0	6.0	ns
t <sub>dis</sub>	disable time	n <mark>OE</mark> to nAn or nBn; see <u>Figure 16</u>	<u>[5]</u>						
		$V_{CC}$ = 2.3 V to 2.7 V		1.0	2.6	5.5	1.0	7.5	ns
		$V_{CC}$ = 3.0 V to 3.6 V		1.0	3.2	5.5	1.0	7.5	ns

[1] All typical values are measured at  $T_{amb}$  = 25 °C and at nominal V<sub>CC</sub>.

[2] The propagation delay is the calculated RC time constant of the on-state resistance of the switch and the load capacitance, when driven by an ideal voltage source (zero output impedance).

[3]  $t_{pd}$  is the same as  $t_{PLH}$  and  $t_{PHL}$ .

[4]  $t_{en}$  is the same as  $t_{PZH}$  and  $t_{PZL}$ .

[5]  $t_{dis}$  is the same as  $t_{PHZ}$  and  $t_{PLZ}$ .

### 11. Waveforms

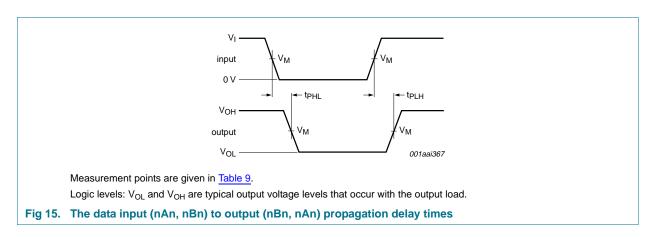


Table 9.	Measurement	points
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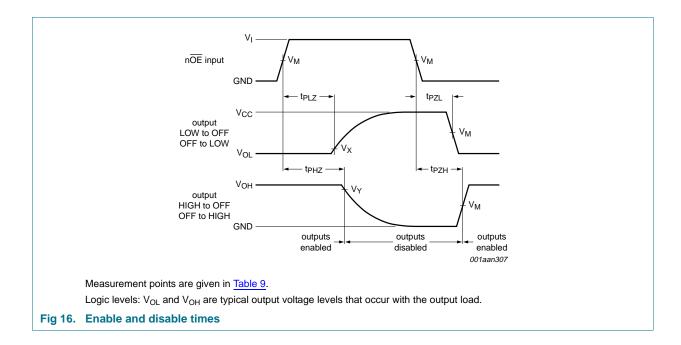
Supply voltage	Input	Input			Output		
V <sub>CC</sub>	V <sub>M</sub>	VI	t <sub>r</sub> = t <sub>f</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>	
2.3 V to 2.7 V	$0.5V_{CC}$	V <sub>CC</sub>	$\leq$ 2.0 ns	$0.5V_{CC}$	V <sub>OL</sub> + 0.15 V	$V_{OH} - 0.15 \ V$	
3.0 V to 3.6 V	$0.5V_{CC}$	V <sub>CC</sub>	$\leq$ 2.0 ns	$0.5V_{CC}$	V <sub>OL</sub> + 0.3 V	$V_{OH} - 0.3 \ V$	

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Product data sheet	Rev. 1 — 30 December 2010	9 of 18

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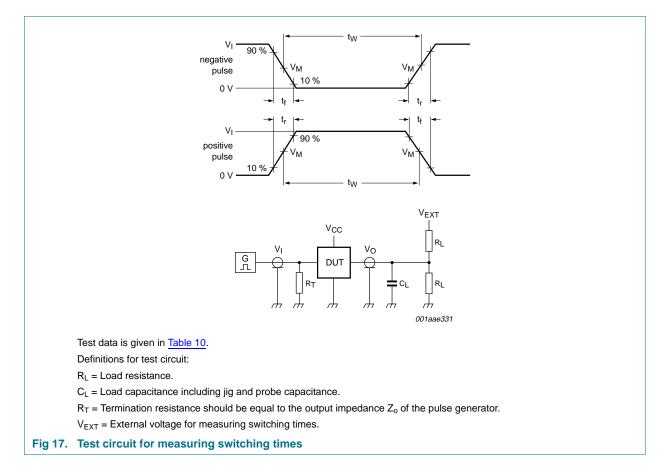
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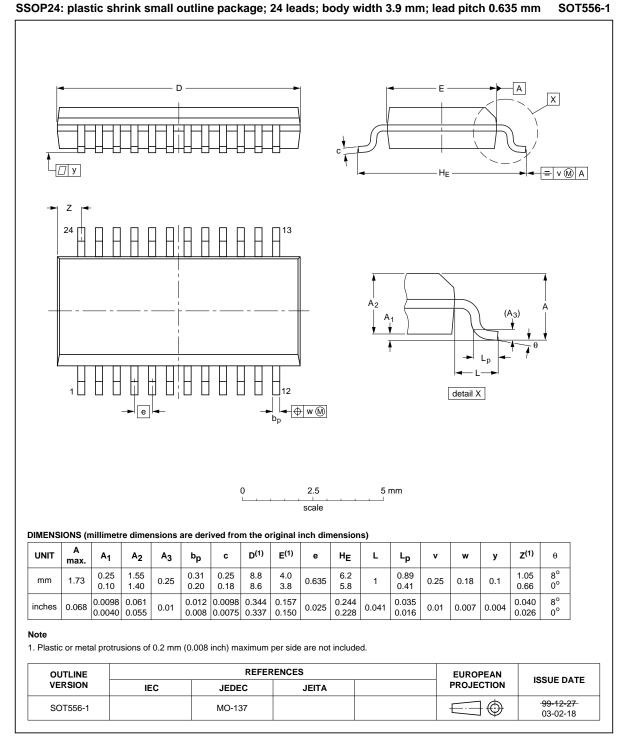


#### Table 10.Test data

Supply voltage	Load		V <sub>EXT</sub>		
V <sub>CC</sub>	CL	R <sub>L</sub>	t <sub>PLH</sub> , t <sub>PHL</sub>	t <sub>PZH</sub> , t <sub>PHZ</sub>	t <sub>PZL</sub> , t <sub>PLZ</sub>
2.3 V to 2.7 V	30 pF	500 Ω	open	GND	2V <sub>CC</sub>
3.0 V to 3.6 V	50 pF	500 Ω	open	GND	2V <sub>CC</sub>

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### 12. Package outline

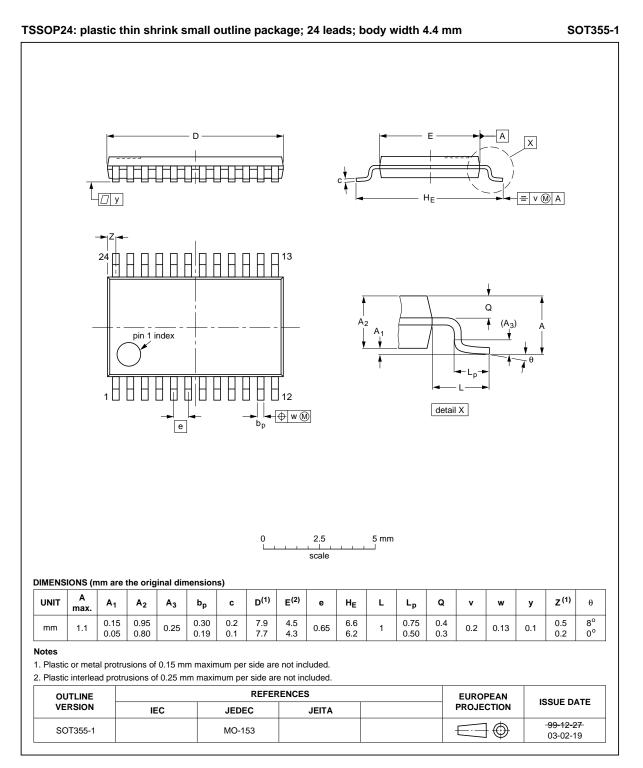


#### Fig 18. Package outline SOT556-1 (SSOP24)

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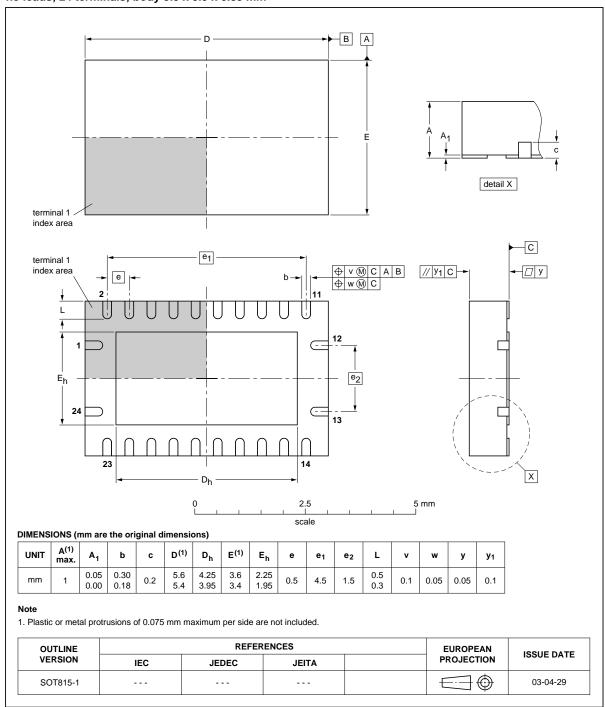
#### Fig 19. Package outline SOT355-1 (TSSOP24)

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Product data sheet

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SOT815-1

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# DHVQFN24: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 24 terminals; body 3.5 x 5.5 x 0.85 mm

Fig 20. Package outline SOT815-1 (DHVQFN24)

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### **13. Abbreviations**

Table 11.	Abbreviations		
Acronym	Description		
CDM	Charged Device Model		
CMOS	Complementary Metal-Oxide Semiconductor		
DUT	Device Under Test		
ESD	ElectroStatic Discharge		
HBM	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

### 14. Revision history

Table 12. Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes		
74CBTLV3384 v.1	20101230	Product data sheet	-	-		

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Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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### **17. Contents**

1	General description 1
2	Features and benefits 1
3	Ordering information 2
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning 3
5.2	Pin description 4
6	Functional description 4
7	Limiting values 4
8	Recommended operating conditions 5
9	Static characteristics 5
9.1	Test circuits 6
9.2	ON resistance 6
9.3	ON resistance test circuit and graphs 7
10	Dynamic characteristics 9
11	Waveforms 9
12	Package outline 12
13	Abbreviations 15
14	Revision history 15
15	Legal information 16
15.1	Data sheet status 16
15.2	Definitions 16
15.3	Disclaimers 16
15.4	Trademarks 17
16	Contact information 17
17	Contents

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